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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Priority Application Serial No. 09/989,960
Priority Filing Date November 21, 2001
Inventor Rickie C. Lake
Assignee Micron Technology, Inc.
Priority Group Art Unit 1733
Priority Examiner J. Haran
Attorney's Docket No. MI40-371
Title: Thin Profile Battery Bonding Method, Method of Conductively Interconnecting
Electronic Components, Battery Powerable Apparatus, Radio Frequency
Communication Device, and Electric Circuit

INFORMATION DISCLOSURE STATEMENT

References - - See attached Form PTO-1449

In compliance with 37 C.F.R. §§ 1.56, 1.97 and 1.98, your attention is directed to the United States patents and other references listed on the attached Form PTO-1449. No admission is made regarding whether all the submitted references are prior art.

The listed references were cited by, or submitted to, the Office in the parent, co-pending application of the above-identified application. The above-identified application is a continuation application of co-pending application Serial No. 09/989,960, filed November 21, 2001, upon which the above-identified application relies for a priority date under 35 U.S.C. §120. Such prior disclosure is sufficient for the above-identified application as far as copies of the references are concerned. 37 C.F.R. §1.98(d) and MPEP §609(2). As a courtesy, Applicant submits copies of the cited articles for review.

Citation of these references is respectfully requested.

Respectfully submitted,

Date: Feb 26, 2004



Deepak Malhotra
Reg. No. 33,560

Form PTO-1449 LIST OF ART CITED BY APPLICANT (Use several sheets if necessary)					ATTY. DOCKET NO. MI40-371	SERIAL NO. Filed Herewith		
					APPLICANT Rickie C. Lake			
					FILING DATE Filed Herewith	(Priority) GROUP 1733		
U.S. PATENT DOCUMENTS								
*Examiner Initial		Document Number	Date	Name	Class	Subclass	Filing Date If Appropriate	
	AA	4,051,161	9/27/77	Proskow				
	AB	4,208,005	6/17/80	Nate et al.				
	AC	4,470,883	9/11/84	Eichelberger et al.				
	AD	5,558,679	9/24/96	Tuttle				
	AE	5,601,941	2/11/97	Tuttle				
	AF	5,843,251	12/1/98	Tsukagoshi et al.				
	AG	4,975,221	12-4-90	Chen et al.				
	AH	5,362,421	11/08/94	Kropp et al.				
	AI	5,728,473	03/17/98	Inoue et al.				
	AJ	5,532,024	07/02/96	Arndt et al.				
	AK	5,783,465	07/21/98	Canning et al.				
FOREIGN PATENT DOCUMENTS								
		Document Number	Date	Country	Class	Subclass	Translation	
							Yes	No
	AL						Yes	No
	AM						Yes	No
	AN						Yes	No
	AO						Yes	No
	AP						Yes	No
OTHER REFERENCES (including Author, Title, Date, Pertinent Pages, Etc.)								
	AQ		Product Information Brochure, "Information About Organofunctional Silane Chemicals," Dow Corning Corporation (date unknown)					
	AR		Product Information Brochure, Information About <i>Dow Corning</i> ® Z-6040 Silane," Dow Corning Corporation (1996)					
	AS		Misczyk et al. Laboratory evaluation of epoxy coatings with an adhesion promoter by impedance. <i>Progress in Organic Coatings</i> 25 (1995) 357-363.					
	AT		Gu et al. Effect of deposition conditions for γ -aminopropyltriethoxy silane on adhesion between copper and epoxy resins. <i>Applied Surface Science</i> 115 (1997) 66-73.					
	AU		Lin et al. Synthesis of novel trifunctional epoxy resins and their modification with polydimethylsiloxane for electronic application. Elsevier Science Ltd. PH: s0032-3861 (96)00713-6 (1996)					
EXAMINER				DATE CONSIDERED				
*EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.								